

FDT86244 N-Channel Power Trench[®] MOSFET 150 V, 2.8 A, 128 m Ω

Features

- Max $r_{DS(on)}$ = 128 m Ω at V_{GS} = 10 V, I_D = 2.8 A
- Max $r_{DS(on)}$ = 178 m Ω at V_{GS} = 6 V, I_D = 2.4 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant



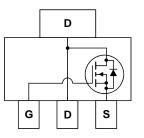
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Primary Switch





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			150	V
V _{GS}	Gate to Source Voltage			±20	V
I _D	Drain Current -Continuous		(Note 1a)	2.8	•
	-Pulsed			12	Α
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	12	mJ
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.2	W
	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0	vv
T _J , T _{STG}	Operating and Storage Junction Ter	mperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	12	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	55	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86244	FDT86244	SOT-223	13 "	12 mm	2500 units

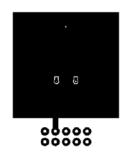
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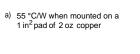
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		104		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	3.1	4.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance $V_{GS} = 6 V, I_D = 2$	V _{GS} = 10 V, I _D = 2.8 A		106	128	
		V _{GS} = 6 V, I _D = 2.4 A		127	178	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.8 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		196	237	
9 FS	Forward Transconductance	V _{DS} = 10 V, I _D = 2.8 A		12		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			295	395	pF
C _{oss}	Output Capacitance	── V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		33	45	pF
C _{rss}	Reverse Transfer Capacitance			2.4	5	pF
R _g	Gate Resistance			1.0		Ω
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			5.3	11	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 2.8 A,		1.3	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{R}_{GEN} = 6 \Omega$		9.8	20	ns
t _f	Fall Time			2.4	10	ns
0	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		4.9	7	nC
⊶q(TOT)	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 5 V$ $I_D = 2.8 \text{ A}$		2.8	4	nC
	Iolal Gale Charge					1
Q _{g(TOT)} Q _{g(TOT)} Q _{gs}	Total Gate Charge	I _D = 2.8 A		1.4		nC

V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.8 A$	(Note 2)	0.82	1.3	V
t _{rr}	Reverse Recovery Time	I _F = 2.8 A, di/dt = 100 A/μs		48	77	ns
Q _{rr}	Reverse Recovery Charge	F = 2.0 A, u/ul = 100 A/	μο	44	70	nC

NOTES:

1. R_{0,0} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,0} is guaranteed by design while R_{0CA} is determined by the user's board design.





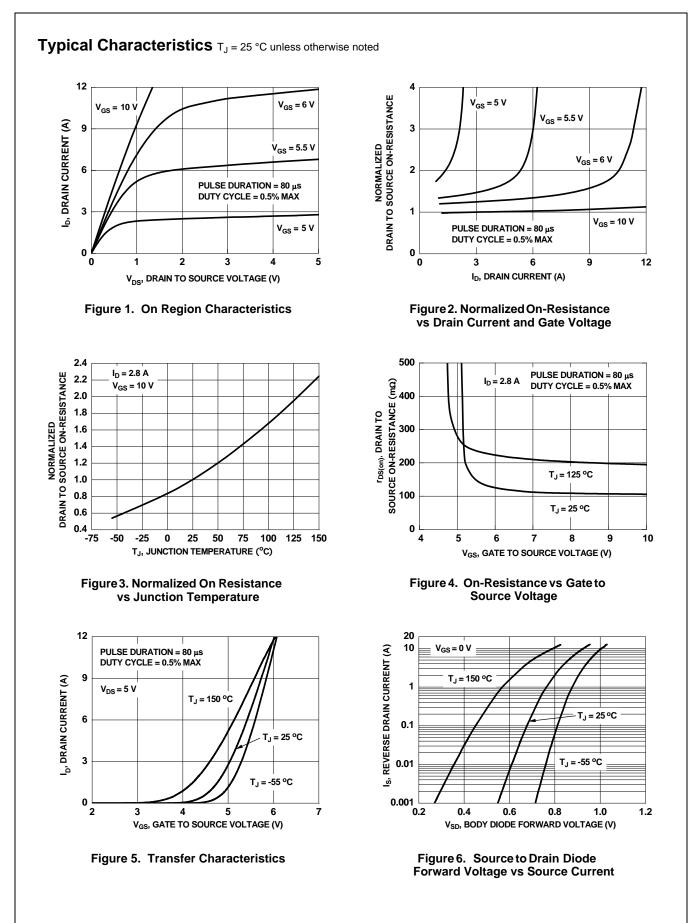


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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

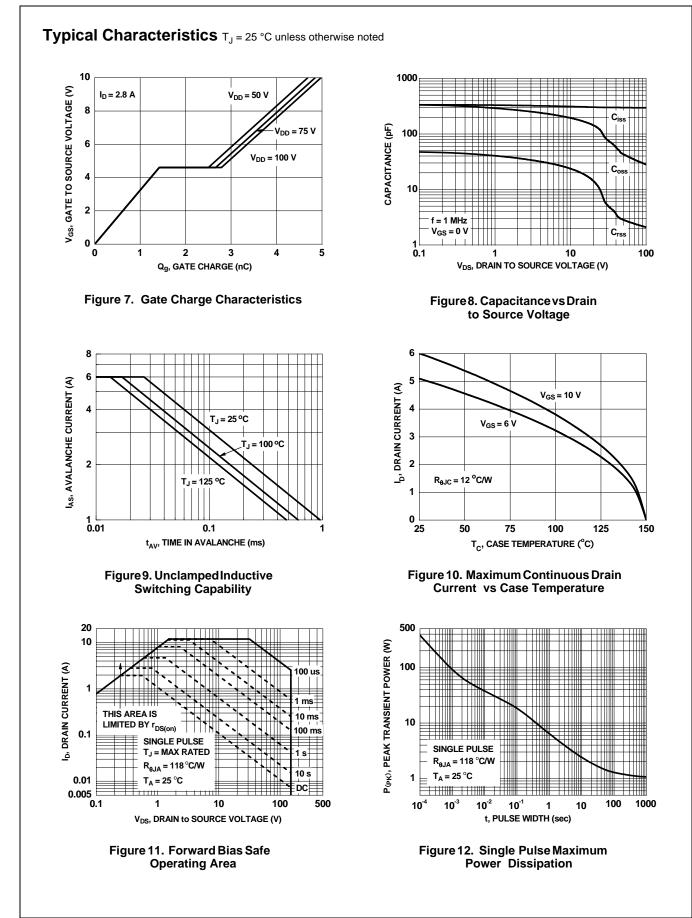
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 °C; N-ch: L = 1 mH, I_{AS} = 5 A, V_{DD} = 135 V, V_{GS} = 10 V.

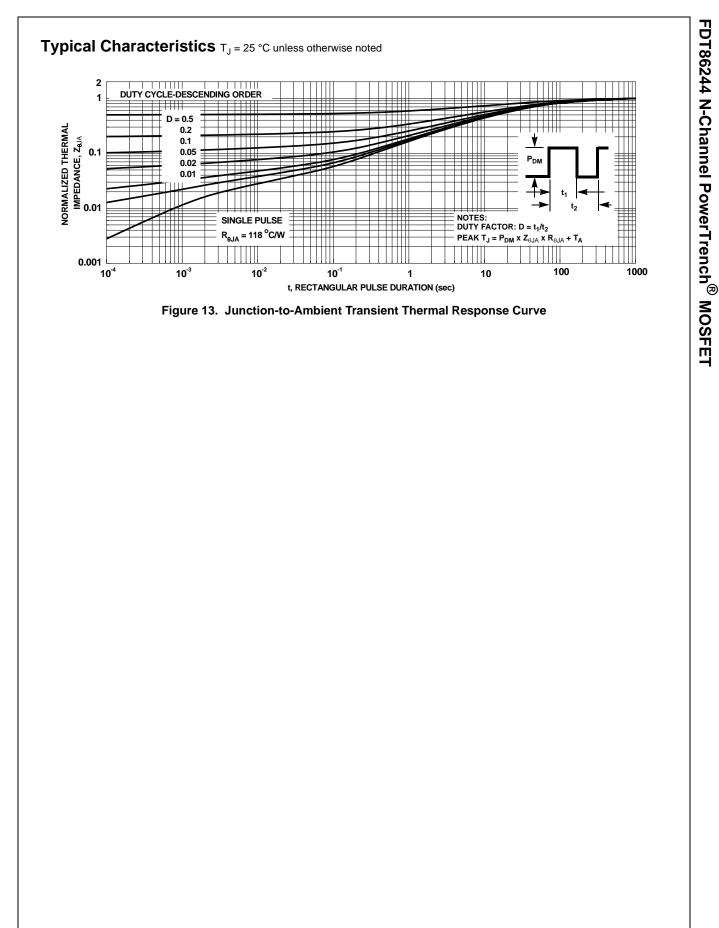


3





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